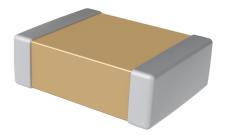


Overview

KEMET's high voltage surface mount MLCCs in COG dielectric feature a 125°C maximum operating temperature and are considered "stable." The Electronics Industries Alliance (EIA) characterizes COG dielectric as a Class I material. Components of this classification are temperature compensating and are suited for resonant circuit applications or those where Q and stability of capacitance characteristics are required. COG exhibits no change in capacitance with respect to time and voltage and boasts a negligible change in capacitance with reference to ambient temperature. Capacitance change is limited to ±30 ppm/°C from -55°C to +125°C.

These devices exhibit low ESR at high frequencies and find conventional use as snubbers or filters in applications such as switching power supplies and lighting ballasts. Their exceptional performance at high frequencies has made high voltage MLCCs the preferred dielectric choice of design engineers worldwide. In addition to their use in power supplies, these capacitors are widely used in industries related to automotive (hybrid), telecommunications, medical, military, aerospace, semiconductors and test/diagnostic equipment. Automotive Grade is available for applications requiring proven, reliable performance in harsh environments. Whether under-hood or in-cabin, these capacitors are designed for mission and safety critical automotive circuits. Stricter testing protocol and inspection criteria have been established for automotive grade products in recognition of potentially harsh environmental conditions. KEMET automotive grade series capacitors meet the demanding Automotive Electronics Council's AEC–Q200 qualification requirements.



Ordering Information

С	1210	С	332	J	С	G	Α	С	TU
Ceramic	Case Size (L" x W")	Specification/ Series	Capacitance Code (pF)	Capacitance Tolerance ¹	Rated Voltage (VDC)	Dielectric	Failure Rate/ Design	Termination Finish ²	Packaging/Grade (C-Spec) ³
	0805 1206 1210 1808 1812 1825 2220 2225	C = Standard	Two significant digits + number of zeros. Use 9 for 1.0 – 9.9 pF Use 8 for 0.5 – .99 pF ex. 2.2 pF = 229 ex. 0.5 pF = 508	$B = \pm 0.10 \text{ pF}$ $C = \pm 0.25 \text{ pF}$ $D = \pm 0.5 \text{ pF}$ $F = \pm 1\%$ $G = \pm 2\%$ $J = \pm 5\%$ $K = \pm 10\%$ $M = \pm 20\%$	C = 500 B = 630 D = 1,000 F = 1,500 G = 2,000 Z = 2,500 H = 3,000	G = COG	A = N/A	C = 100% Matte Sn L = SnPb (5% minimum)	Blank = Bulk Bag (Commercial Grade) TU = 7" Reel (Commercial Grade) AUTO = 7" Reel (Automotive Grade) AUTO 7411 = 13" Reel/Punched Paper (Automotive Grade) AUTO 7210 = 13" Reel /Embossed Plastic (Automotive Grade)

¹ Additional capacitance tolerance offerings may be available. Contact KEMET for details.

² SnPb termination finish option is not available on Automotive Grade product.

^{2,3} Additional termination finish options may be available. Contact KEMET for details.

³ Additional reeling or packaging options may be available. Contact KEMET for details.

³ Reeling tape options (Paper or Plastic) are dependent on capacitor case size (L"x W") and thickness dimension. See "Chip Thickness/Packaging Quantities" and "Tape & Reel Packaging Information" sections of this document.

³ For additional Information regarding "AUTO" C-Spec options, see "Automotive C-Spec Information" section of this document.



Automotive C-Spec Information

KEMET Automotive Grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC–Q200, Stress Test Qualification for Passive Components. These products are supported by a Product Change Notification (PCN) and Production Part Approval Process warrant (PPAP).

Automotive products offered through our distribution channel have been assigned an inclusive ordering code C-Spec, "AUTO". This C-Spec was developed in order to better serve small and medium sized companies that prefer an automotive grade component without the requirement to submit a customer Source Controlled Drawing (SCD) or specification for review by a KEMET engineering specialist. This C-Spec is therefore not intended for use by KEMET's OEM Automotive customers and are not granted the same "privileges" as other automotive C-Specs. Customer PCN approval and PPAP request levels are limited (see details below).

Product Change Notification (PCN)

The KEMET Product Change Notification system is used to communicate primarily the following types of changes:

- · Product/process changes that affect product form, fit , function, and /or reliability
- · Changes in manufacturing site
- Product obsolescence

KEMET Automotive	Customer Noti	fication due to:	Days prior to
C-Spec	Process/Product change	Obsolescence*	implementation
KEMET assigned ¹	Yes (with approval and sign off)	Yes	180 days Minimum
AUTO	Yes (without approval)	Yes	90 days Minimum

¹ KEMET assigned C-Specs require the submittal of a customer SCD or customer specification for review. For additional information contact KEMET.

Production Part Approval Process (PPAP)

The purpose of the Production Part Approval Process is:

- To ensure that supplier can meet the manufacturability and quality requirements for the purchased parts.
- To provide the evidence that all customer engineering design record and specification requirements are properly understood and fulfilled by the manufacturing organization.
- To demonstrate that the established manufacturing process has the potential to produce the part

KEMET Automotive		PPAP (Product	Part Approval	Process) Level	
C-Spec	1	2	3	4	5
KEMET assigned ¹	•	•	•	•	•
AUTO	0		0		

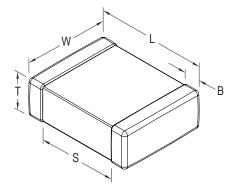
¹ KEMET assigned C-Specs require the submittal of a customer SCD or customer specification for review. For additional information contact KEMET.

• Part Number specific PPAP available

• Product family PPAP only



Dimensions – Millimeters (Inches)



EIA Size Code	Metric Size Code	L Length	W Width	T Thickness	B Bandwidth	S Separation Minimum	Mounting Technique
0805	2012	2.00 (.079) ±0.20 (.008)	1.25 (.049) ±0.20 (.008)		0.50 (0.02) ±0.25 (.010)	0.75 (.030)	Solder Wave or
1206	3216	3.20 (.126) ±0.20 (.008)	1.60 (.063) ±0.20 (.008)		0.50 (0.02) ±0.25 (.010)		Solder Reflow
1210	3225	3.20 (.126) ±0.20 (.008)	2.50 (.098) ±0.20 (.008)		0.50 (0.02) ±0.25 (.010)		
1808	4520	4.70 (.185) ±0.50 (.020)	2.00 (.079) ±0.20 (.008)	See Table 2 for	0.60 (.024) ±0.35 (.014)		
1812	4532	4.50 (.177) ±0.30 (.012)	3.20 (.126) ±0.30 (.012)	Thickness	0.60 (.024) ±0.35 (.014)	N/A	Califan Daflaw Only
1825	4564	4.50 (.177) ±0.30 (.012)	6.40 (.252) ±0.40 (.016)		0.60 (.024) ±0.35 (.014)		Solder Reflow Only
2220	5650	5.70 (.224) ±0.40 (.016)	5.00 (.197) ±0.40 (.016)		0.60 (.024) ±0.35 (.014)		
2225	5664	5.60 (.220) ±0.40 (.016)	6.40 (.248) ±0.40 (.016)		0.60 (.024) ±0.35 (.014)		

Benefits

- -55°C to +125°C operating temperature range
- · Lead (Pb)-Free, RoHS and REACH compliant
- EIA 0805, 1206, 1210, 1808, 1812, 1825, 2220, and 2225 case sizes
- DC voltage ratings of 500 V, 630 V, 1 KV, 1.5 KV, 2 KV, 2.5 KV, and 3 KV
- Capacitance offerings ranging from 1 pF to 0.039 μ F
- Available capacitance tolerances of ±0.10 pF, ±0.25 pF, ±0.5 pF, ±1%, ±2%, ±5%, ±10%, and ±20%
- · No piezoelectric noise
- Extremely low ESR and ESL
- High thermal stability
- High ripple current capability

- Preferred capacitance solution at line frequencies & into the MHz range
- · No capacitance change with respect to applied rated DC voltage
- Negligible capacitance change with respect to temperature from -55°C to +125°C
- · No capacitance decay with time
- Non-polar device, minimizing installation concerns
- Commercial & Automotive (AEC-Q200) grades available
- 100% pure matte tin-plated termination finish allowing for excellent solderability
- SnPb plated termination finish option available upon request (5% minimum)



Applications

Typical applications include switch mode power supplies (input filters, resonators, tank circuits, snubbed circuits, output filters), high voltage coupling and DC blocking, lighting ballasts, voltage multiplier circuits, DC/DC converters and coupling capacitors in Ćuk converters. Markets include power supply, LCD fluorescent backlight ballasts, HID lighting, telecom equipment, industrial and medical equipment/control, LAN/WAN interface, analog and digital modems, and automotive.

Qualification/Certification

Commercial Grade products are subject to internal qualification. Details regarding test methods and conditions are referenced in Table 4, Performance & Reliability.

Automotive Grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC–Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC–Q200, please visit their website at www.aecouncil.com.

Environmental Compliance

Lead (Pb)-Free, RoHS, and REACH compliant without exemptions (excluding SnPb termination finish option).



Electrical Parameters/Characteristics

Item	Parameters/Characteristics
Operating Temperature Range	-55°C to +125°C
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	±30 ppm/°C
Aging Rate (Maximum % Capacitance Loss/Decade Hour)	0%
Dielectric Withstanding Voltage (DWV)	150% of rated voltage for voltage rating of < 1,000 V 120% of rated voltage for voltage rating of \ge 1,000 V (5 ±1 seconds and charge/discharge not exceeding 50 mA)
Dissipation Factor (DF) Maximum Limit at 25°C	0.1%
Insulation Resistance (IR) Limit at 25°C	1,000 megohm microfarads or 100 G Ω (500 VDC applied for 120 ±5 seconds at 25°C)

To obtain IR limit, divide $M\Omega$ - μ F value by the capacitance and compare to $G\Omega$ limit. Select the lower of the two limits.

Capacitance and dissipation factor (DF) measured under the following conditions:

1 MHz ±100 kHz and 1.0 Vrms ±0.2 V if capacitance ≤ 1,000 pF

1 kHz ±50 Hz and 1.0 Vrms ±0.2 V if capacitance > 1,000 pF

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 and Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON."

Post Environmental Limits

	High Temperatu	ıre Life, Biased	Humidity, Mois	ture Resistance	•										
Dielectric	Dielectric Rated DC Voltage Capacitance Value Dissipation Factor (Maximum %) Capacitance Shift Insulation Resistance														
C0G	All	All	0.5	0.3% or ±0.25 pF	10% of Initial Limit										



Table 1A – Capacitance Range/Selection Waterfall (0805 – 1808 Case Sizes)

		Cas	se Si	ze/	Sei	ries		C	0805	5C		С	1206	C			С	1210	C				С	1808	SC		
	Сар		Volta	ge C	ode		Т	с	в	D	С	в	D	F	G	с	в	D	F	G	с	в	D	F	G	z	н
Capacitance	Code	Ra	ted Vo	Itag	e (VD)C)	İ	500	630	1000	500	630	1000	1500	2000	500	630	1000	1500	2000	500	630	1000	1500	2000	2500	3000
	oouc		Capa					4,	e	-	L 47			•						ickne				-	7	7	e
4.0 04 -5*	400 040*		Tole	ran	ice		_	DO	DO	DO			See	e Tab	le 2 1	for C	hip T	hick	ness	Dim	_						
1.0 – 9.1 pF* 10 pF - 47pF*	109 – 919* 100 - 470*	ВС	D	G	J	к	м	DG DG	DG DG	DG DG	EG	EG	EG	EG	EG	FM	FM	FM	FM	FM	LB LB						
51 pF	510		F					DG	DG	DG	EF	EF	EF	EG	EG	FM	FM	FM	FM	FM	LB						
56 pF	560		F				М	DG	DG	DG	EF	EF	EF	EG	EG	FM	FM	FM	FM	FM	LB						
62 pF	620 680		F	-	_		M	DG	DG DG	DG DG	EF EF	EF EF	EF EF	EG EG	EG EG	FM FM	FM FM	FM FM	FM FM	FM FM	LB LB	LB LB	LB LB	LB LB	LB LB	LB	LB LB
68 pF 75 pF	750			-			M M	DG DG	DG	DG	EF	EF	EF	EG	EG	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LB LB	LB
82 pF	820		F	-			М	DG	DG	DG	EF	EF	EF	EG	EG	FM	FM	FM	FM	FM	LB						
91 pF	910		F	-			М	DG	DG	DG	EF	EF	EF	EG	EG	FM	FM	FM	FM	FM	LB						
100 pF	101		F	-	_		М	DG	DG	DG	EF	EF	EF	EG	EG	FM	FM	FM	FM	FM	LB	LB	LB	LB	LB	LC	LB
110 pF 120 pF	111 121		F				M M	DG DG	DG DG	DG DG	EF EF	EF EF	EF EF	EG EG	EG EG	FM FG	FM FG	FM FG	FM FM	FM FM	LB LA	LB LA	LB LA	LB LA	LB LB	LC LC	LB LB
130 pF	121		F				M	DG	DG	DG	EF	EF	EF	EG	EG	FG	FG	FG	FM	FM	LA	LA	LA	LA	LB	LC	LD
150 pF	151		F	G		K	М	DG	DG	DG	EF	EF	EF	EG	EG	FG	FG	FG	FM	FM	LA	LA	LA	LA	LB	LC	LC
160 pF	161		F	_	_	K	М	DG	DG	DG	EF	EF	EF	EG	EG	FG	FG	FG	FM	FM	LA	LA	LA	LA	LC	LC	LC
180 pF	181 201		F				M	DG	DG DG	DG DG	EF EF	EF EG	EF EG	EG EG	EG EG	FG FG	FG FG	FG FG	FM FM	FM FM	LA LA	LA	LA	LA LA	LC LC	LC LC	LC
200 pF 220 pF	201 221		F	-				DG DG	DG	DG	EF	EG	EG	EG	EG	FG	FG	FG	FM	FM	LA	LA LA	LA LA	LA	LC	LC	
240 pF	241		F	-			М	DG	DG	DG	EF	EG	EG	EG	EG	FG	FG	FG	FM	FM	LA	LA	LA	LB	LC	LC	
270 pF	271		F	G	J	K	М	DG	DG	DG	EF	EG	EG	EG	EG	FG	FG	FG	FK	FK	LA	LA	LA	LB	LC	LC	
300 pF	301		F	-			М	DG	DG		EF	EG	EG	EG		FG	FG	FG	FK	FK	LA	LA	LA	LB	LC	LC	
330 pF	331 361		F	-			М	DG DG	DG DG		EF	EG EG	EG EG	EG EG		FG FG	FG FG	FG FG	FK FK	FK FS	LA LA	LA	LA	LB LB	LC LA	LC LC	
360 pF 390 pF	301		F				M M	DG	DG		EG EG	EG	EG	EG		FG	FG	FG	FK	FS	LA	LA LA	LA LA	LB	LA	LC	
430 pF	431		F				м	DG	DG		EG	EG	EG	EG		FG	FM	FM	FS	FS	LA	LB	LB	LC	LA	20	
470 pF	471		F	-		K	М	DG	DG		EG	EG	EG	EG		FG	FM	FM	FS	FS	LA	LB	LB	LC	LA		
510 pF	511		F	-			М	DG	DG		EG	EG	EG	EG		FG	FM	FM	FS	FS	LA	LB	LB	LC	LB		
560 pF 620 pF	561 621		F	-			M M	DG DG	DG		EG EG	EG EG	EG EG	EG		FG FG	FM FM	FM FM	FS FS	FS FS	LA LA	LB LB	LB LB	LC LA	LB LC		
680 pF	681		F	-			M	DG			EG	EG	EG			FG	FM	FM	FS	FS	LA	LB	LB	LA	LC		
750 pF	751		F	-	_	K	М	DG			EG	EF	EG			FG	FM	FM	FM		LB	LB	LB	LA			
820 pF	821		F			K	М	DG			EG	EF	EG			FG	FM	FM	FM		LB	LB	LB	LA			
910 pF	911		F				М				EG	EF	EG			FM	FM	FM	FY		LB	LB	LB	LA			
1,000 pF 1,100 pF	102 112		F	-			M M				EG EF	EF EG	EG			FM FM	FM FK	FM FK	FY FS		LB LC	LB LC	LB LC	LB LB			
1,200 pF	12		F	-	-		M	_			EF	EG				FM	FK	FK	FS		LC	LC	LC	LC			
1,300 pF	132		F	-			М				EF	EG				FM	FS	FS			LC	LC	LC	LC			
1,500 pF	152		F	-			М				EF	EG				FK	FS	FS			LC	LC	LC	LC			
1,600 pF	162		F	-			М				EF	EG				FK	FS	FS			LC	LC	LC				
1,800 pF 2,000 pF	182 202		F	-	_		M M				EF EG	EG EB				FK FK	FS FL	FS FS			LC LC	LC LA	LC LB				
2,200 pF	202		F	-			M				EG	EB				FK	FL	FS			LC	LA	LB				
2,400 pF	242		F	G		K	М				EG	EB				FS	FL	FS			LC	LA	LB				
2,700 pF	272		F				М				EG	EB				FS	FL	FS			LC	LA	LC				
3,000 pF 3,300 pF	302 332		F	_	_		M				EB EB	EB EB				FS FS	FL FM				LA	LA					
3,300 pF 3,600 pF	332 362		F	-			M M				EC	EC				FS	FM				LA LA	LA LB					
3,900 pF	392		F	-			М				EC	EC				FL	FY				LA	LB					
4,300 pF	432		F	G	J	K	М				ED	ED				FM	FY				LA	LC					
4,700 pF	472			-	_						ED	ED				FM	FY				LA	LC					
5,100 pF	512					· · · · ·	IVI	0	0	2	0	0	0	2	2	FY	FS	0	2	0	LA	0	2	0	0	0	0
Canacitanco	Сар	Ra		F G J K M F G J K M Joltage (VDC)		630	1000	500	630	1000	1500	2000	500	630	1000	1500	2000	500	630	1000	1500	2000	2500	3000			
Capacitance	Code			Voltage (VDC) 중 tage Code C		B	D	C	В	D	F	G	C	В	D	F	G	C	В	D	F	G	Z	Η			
		Cas	se Si				0805	C		C	1206	С			C	1210	С				С	1808	C				

*Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82 and 91) KEMET reserves the right to substitute product with an improved temperature characteristic, tighter capacitance tolerance and/or higher voltage capability within the same form factor (configuration and dimensions).

These products are protected under US Patents 7,172,985 and 7,670,981, other patents pending, and any foreign counterparts.



Table 1A – Capacitance Range/Selection Waterfall (0805 – 1808 Case Sizes) cont'd

		Case Size/Series	С	0805	5C		С	1206	C			С	1210	C				C	1808	C		
	Сар	Voltage Code	с	в	D	С	в	D	F	G	С	в	D	F	G	с	в	D	F	G	Z	н
Capacitance	Code	Rated Voltage (VDC)	500	630	1000	500	630	1000	1500	2000	500	630	1000	1500	2000	500	630	1000	1500	2000	2500	3000
		Capacitance Tolerance					F					y anc hip T						6				
5,600 pF	562	F G J K M									FY	FS				LB						
6,200pF	622	F G J K M									FY	FE				LC						
6,800pF	682	F G J K M									FY	FE				LC						
7,500pF	752	F G J K M									FS											
8,200pF	822	F G J K M									FS											
	Can	Rated Voltage (VDC)	500	630	1000	500	630	1000	1500	2000	500	630	1000	1500	2000	500	630	1000	1500	2000	2500	3000
Capacitance	Cap Code	Voltage Code	С	В	D	С	В	D	F	G	С	В	D	F	G	С	В	D	F	G	Z	Η
		Case Size/Series	3 J K M 3 J K M 4 J K M				С	1206	с			С	1210	С				С	1808	с		

*Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82 and 91) KEMET reserves the right to substitute product with an improved temperature characteristic, tighter capacitance tolerance and/or higher voltage capability within the same form factor (configuration and dimensions).

These products are protected under US Patents 7,172,985 and 7,670,981, other patents pending, and any foreign counterparts.

Table 1B – Capacitance Range/Selection Waterfall (1812 – 2225 Case Sizes)

		Case Size/ Series			C1	812	2C					C 1	82	5C					C2	222	0C					C2	222	5C		
Capacitance	Сар	Voltage Code	с	в	D	F	G	z	н	с	в	D	F	G	z	н	с	в	D	F	G	z	н	c	в	D	F	G	z	н
Capacitance	Code		500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000
		Rated Voltage (VDC)	2	ő	9	15	20	25	30															20	6	9	15	20	25	8
		Capacitance																			ss									
		Tolerance																			ens									
10 - 91 pF*	100 - 910*	FGJKM				GK				HG				HG		HG		JK	JK	JK	JK	JK		KF	KF	KF	KF	KF	KF	KF
100 - 180 pF*	101 - 181*	FGJKM	0	GK	GK	GK	GK	GK	GK		HG	HG	HG	HG	HG	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF
200 pF	201	F G J K M	GH		GH	GH	GH	GK	GM		ΗE	HE	HE	HE	HE	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF
220 pF	221	F G J K M	GH		GH	GH	GH	GK		HE	HE	ΗE	HE	HE	HE	HG	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KF	KF	KF
240 pF	241	F G J K M	GH	-	-	GH	GH	GK	GM		HE	ΗE	HE	HE	HE	HG		JK	JK	JK	JK	JK	JK	KE	KE	KE	KE	KE	KE	KF
270 pF	271	F G J K M		-	GH	GH	GH	GK	GM		ΗE	HE	HE	HE	HE	HG	JK	JK	JK	JK	JK	JK	JK	KE	KE	KE	KE	KE	KE	KF
300 pF	301	F G J K M	~	-	GH	GH	GH		GM		ΗE	HE	HE	HE	HE	HG	JK	JK	JK	JK	JK	JK	JK	KE	KE	KE	KE	KE	KE	KF
330 pF	331	F G J K M		-	GH	GH	÷	GK	GO		ΗE	HE	HE	HE	HE	HG	JE	JE	JE	JE	JE	JK	JK	KE	KE	KE	KE	KE	KE	KF
360 pF	361	F G J K M	GK	GK	GK	GK	-		GO		ΗE	HE	HE	HE	HE	HG	JE	JE	JE	JE	JE	JK	JK	KE	KE	KE	KE	KE	KE	KF
390 pF	391	F G J K M	GK	GK	GK	GK	GK	GK	GO		ΗE	HE	HE	HE	HE	HG	JE	JE	JE	JE	JE	JK	JK	KE	KE	KE	KE	KE	KE	KF
430 pF	431	F G J K M	GK	GK	GK	GK	GK	GK		HE	ΗE	HE	HE	HE	HE	HJ	JE	JE	JE	JE	JE	JK	JE	KE	KE	KE	KE	KE	KE	KF
470 pF	471	F G J K M	GK	GK	GK	GK	GK	GK		HE	ΗE	HE	HE	HE	HE	HJ	JE	JE	JE	JE	JE	JK	JK	KF	KF	KF	KF	KE	KE	KF
510 pF	511	F G J K M	GH	GH	GH	GK	GH	GM		ΗE	ΗE	ΗE	HE	HE	HE	HJ	JK	JK	JK	JK	JK	JK	JK	KF	KF	KF	KF	KE	KE	KF
560 pF	561	F G J K M	GH	GH	GH	GK	GH	GM		HE	ΗE	ΗE	HE	HG	HE	HJ	JK	JK	JK	JK	JK	JK	JL	KF	KF	KF	KF	KE	KE	KF
620 pF	621	F G J K M	GH	GH	GH	GK	GH	GM		HE	ΗE	ΗE	HE	HG	HE	HK	JK	JK	JK	JK	JK	JK	JL	KF	KF	KF	KF	KE	KF	KH
680 pF	681	F G J K M	GH	GH	GH	GK	GH	GO		ΗE	ΗE	ΗE	HE	HG	HG	HK	JE	JE	JE	JK	JK	JK	JL	KF	KF	KF	KF	KE	KF	KH
750 pF	751	F G J K M	GH	GH	GH	GK	GK			ΗE	ΗE	HE	HG	HG	HG		JE	JE	JE	JK	JK	JK	JL	KE	KE	KE	KF	KE	KF	KH
820 pF	821	F G J K M	GH	GH	GH	GK	GK			ΗE	ΗE	HE	HG	HG	HG		JE	JE	JE	JK	JK	JK	JN	KE	KE	KE	KF	KE	KF	KJ
910 pF	911	F G J K M	GH	GH	GH	GH	GM			ΗE	ΗE	HE	HG	HG	HG		JE	JK	JK	JK	JK	JK	JN	KE	KE	KE	KF	KE	KF	KJ
1,000 pF	102	F G J K M	GH	GH	GH	GH	GM			ΗE	ΗE	HE	HG	HG	HG		JE	JK	JK	JK	JK	JK	JN	KE	KE	KE	KF	KE	KF	KJ
1,100 pF	112	F G J K M	GH	GK	GK	GH	GO			HE	ΗE	HE	HG	HG	HJ		JE	JK	JK	JK	JK	JK		KE	KE	KE	KF	KF	KF	
		Rated Voltage (VDC)	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000
Capacitance	Con		с	в	D	F	G	z	Н	с	в	D	F	G	z	Н	с	в	D	F	G	z	Н	с	в	D	F	G	z	H
	Code	Case Size/Series	Code C B D	C1	1812	20					C,	182	5C					C	222	0C					C	222	5C			

*Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82 and 91) KEMET reserves the right to substitute product with an improved temperature characteristic, tighter capacitance tolerance and/or higher voltage capability within the same form factor (configuration and dimensions).

These products are protected under US Patents 7,172,985 and 7,670,981, other patents pending, and any foreign counterparts.



Table 1B – Capacitance Range/Selection Waterfall (1812 – 2225 Case Sizes) cont'd

		Case Size/ Series			C 1	812	2C					C 1	82	5C					C2	222	0C					C2	222	5C		
Capacitance	Сар	Voltage Code	с	в	D	F	G	z	н	С	в	D	F	G	z	н	с	в	D	F	G	z	н	с	в	D	F	G	z	н
	Code	Rated Voltage (VDC)	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000
		Capacitance Tolerance								Pre	odu	ct A	Vai	labi	lity	anc	I Ch	ір Т	hic	kne	ss (ensi	Cod	les							
1,200 pF	122	F G J K M	GH	GK	GK	GH	GO			HE	HE	HE	HG	HG	HJ	рт	JE	JK	JK	JK	JK	JL	>	KE	KE	KE	KF	KF	KF	
1,300 pF	132	FGJKM	GH	GK	GK	GH	GO			HE	HE	HE	HG	HE	HJ		JE	JK	JK	JK	JE	JL		KE	KE	KE	KF	KF	KH	
1,500 pF	152	F G J K M	GK	GK	GK	GK				HE	HE	HE	HG	HE	HK		JE	JK	JK	JK	JE	JL		KE	KE	KE	KF	KF	KH	
1,600 pF	162	FGJKM	GK	GK	GK		00			HE		HG	HG	HG	нк		JE	JK	JK	JK	JE	JL		KE	KE	KE	KF	KE	KH	
1,800 pF	182	F G J K M	GK	GK	GK	GM				HE	HG	-	HG	HG	T IIX		JE	JK	JK	JK	JE	JN		KE	KE	KE	KF	KE	KH	
2,000 pF	202	FGJKM	GK	GK	GK	GM				HE	HG	HG	HE	HJ			JE	JK	JK	JE	JK			KE	KE	KE	KF	KE	KJ	
2,200 pF	222	FGJKM	GK	GK	GK	GO				HE	HG	HG	HE	HJ			JE	JK	JK	JE	JK			KE	KE	KE	KF	KE	KJ	
2,400 pF	242	FGJKM	GK	GH	GK	GO				HE		HG	HE	HJ			JK	JK	JK	JE	JL			KE	KE	KE	KE	KH		
2,700 pF	272	F G J K M	GK	GH	GK	GO				HE	HG	HG	HE	нк			JK	JK	JK	JE	JL			KE	KE	KE	KE	КН		
3,000 pF	302	F G J K M			GK					HG	HG	HG	HE	HK			JK	JK	JK	JE	JL			KE	KE	KE	KE	KH		
3,300 pF	332	FGJKM		GH	GK					HG		HG	HG				JK	JK	JK	JK	JN			KE	KE	KE	KE	KJ		
3,600 pF	362	FGJKM	GK		GM					HG	HG	HG	HG				JK	JK	JK	JK	JN			KE	KF	KF	KF	KJ		
3,900 pF	392	FGJKM	-		GM					HG		HG	HJ				JK	JK	JK	JK	JN			KE	KF	KF	KF	KJ		
4,300 pF	432	F G J K M	-		GO					HG		HG	HJ				JK	JK	JK	JK	•			KE	KF	KF	KF			
4,700 pF	472	FGJKM	-	-	GO					HG	-	HG	HJ				JK	JK	JK	JL				KE	KF	KF	KH			
5,100 pF	512	FGJKM	GH	GK	GO					HG		HG	нк				JK	JK	JK	JL				KE	KF	KF	КН			
5,600 pF	562	FGJKM	GH	GK	GO					HG	HE	HG	нк				JK	JK	JK	JN				KE	KF	KF	КН			
6,200 pF	622	FGJKM		GK						HG	HE	HG					JK	JE	JE	JN				KE	KF	KF	КJ			
6,800 pF	682	FGJKM	GH	GM						HG	HE	HJ					JK	JE	JK	JN				KE	KF	KF	KJ			
7,500 pF	752	F G J K M		GM						HG	HE	HJ					JK	JE	JK					KF	KE	KF				
8,200 pF	822	F G J K M	GK	GO						НG	HE	HJ					JK	JE	JL					KF	KE	KF				
9,100 pF	912	F G J K M	GM	GO						HE	HG	ΗК					JE	JE	JL					KF	KE	КН				
10,000 pF	103	FGJKM	GM	GO						HE	HG	ΗK					JE	JE	JL					KF	KE	KH				
12,000 pF	123	F G J K M	GO							HE	HG						JE	JK	JN					KE	KE	KH				
15,000 pF	153	F G J K M	GO							ΗE	HJ						JE	JL						KE	KF	KJ				
18,000 pF	183	F G J K M								HG	ΗK						JE	JL						KE	KH					
22,000 pF	223	F G J K M								НJ							JK	JN						KF	KJ					
27,000 pF	273	F G J K M								HJ							JL	JN						KF	KJ					
33,000 pF	333	F G J K M								ΗК							JN							КΗ						
39,000 pF	393	F G J K M																						KJ						
		Rated Voltage (VDC)	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000	500	630	1000	1500	2000	2500	3000
Consoitance	Сар	Voltage Code	c	В	- D	F	∾ G	∼ Z	т н	c	В	- D	F	G	∼ Z	е Н	c	В	- D	F	G	∼ Z	т Н	c	В	- D	F	G	∾ Z	е Н
Capacitance	Code	Case Size/Series		J		1812	-	-			5		1825	-	L			5		222(-	L		ľ			222		-	

*Capacitance range Includes E24 decade values only. (i.e., 10, 11, 12, 13, 15, 16, 18, 20, 22, 24, 27, 30, 33, 36, 39, 43, 47, 51, 56, 62, 68, 75, 82 and 91) KEMET reserves the right to substitute product with an improved temperature characteristic, tighter capacitance tolerance and/or higher voltage capability within the same form factor (configuration and dimensions).

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Table 2 – Chip Thickness/Packaging Quantities

Thickness	Case	Thickness ±	Paper C	uantity	Plastic (Quantity
Code	Size	Range (mm)	7" Reel	13" Reel	7" Reel	13" Reel
DG	0805	1.25 ± 0.15	0	0	2,500	10,000
EB	1206	0.78 ± 0.10	4000	10000	4,000	10,000
EC	1206	0.90 ± 0.10	0	0	4,000	10,000
ED	1206	1.00 ± 0.10	0	0	2,500	10,000
EF	1206	1.20 ± 0.15	0	0	2,500	10,000
EG	1206	1.60 ± 0.15	0	0	2,000	8,000
FE	1210	1.00 ± 0.10	0	0	2,500	10,000
FG	1210	1.25 ± 0.15	0	0	2,500	10,000
FL	1210	1.40 ± 0.15	0	0	2,000	8,000
FM	1210	1.70 ± 0.20	0	0	2,000	8,000
FY	1210	2.00 ± 0.20	0	0	2,000	8,000
FK	1210	2.10 ± 0.20	0	0	2,000	8,000
FS	1210	2.50 ± 0.30	0	0	1,000	4,000
LA	1808	1.40 ± 0.15	0	0	1,000	4,000
LB	1808	1.60 ± 0.15	0	0	1,000	4,000
LC	1808	2.00 ± 0.15	0	0	1,000	4,000
GH	1812	1.40 ± 0.15	0	0	1,000	4,000
GK	1812	1.60 ± 0.20	0	0	1,000	4,000
GM	1812	2.00 ± 0.20	0	0	500	2,000
GO	1812	2.50 ± 0.20	0	0	500	2,000
HE	1825	1.40 ± 0.15	0	0	1,000	4,000
HG	1825	1.60 ± 0.20	0	0	1,000	4,000
HJ	1825	2.00 ± 0.20	0	0	500	2,000
HK	1825	2.50 ± 0.20	0	0	500	2,000
JE	2220	1.40 ± 0.15	0	0	1,000	4,000
JK	2220	1.60 ± 0.20	0	0	1,000	4,000
JL	2220	2.00 ± 0.20	0	0	500	2,000
JN	2220	2.50 ± 0.20	0	0	500	2,000
KE	2225	1.40 ± 0.15	0	0	1,000	4,000
KF	2225	1.60 ± 0.20	0	0	1,000	4,000
KH	2225	2.00 ± 0.20	0	0	500	2,000
KJ	2225	2.50 ± 0.20	0	0	500	2,000
Thickness	Case	Thickness ±	7" Reel	13" Reel	7" Reel	13" Reel
Code	Size	Range (mm)	Paper C	uantity	Plastic (Quantity

Package quantity based on finished chip thickness specifications.



Table 3 – Chip Capacitor Land Pattern Design Recommendations per IPC–7351

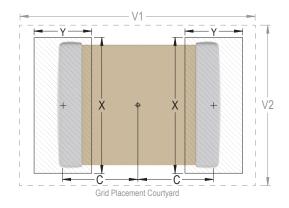
EIA Size Code	Metric Size Code			sity Lev mum (I rotrusio	Nost))		Medi	sity Lev an (Nor rotrusio)		Minii	sity Lev num (L rotrusio)
oouc	oode	С	Y	X	V1	V2	С	Y	X	V1	V2	С	Y	Х	V1	V2
0805	2012	1.00	1.35	1.55	4.40	2.60	0.90	1.15	1.45	3.50	2.00	0.75	0.95	1.35	2.80	1.70
1206	3216	1.60	1.35	1.90	5.60	2.90	1.50	1.15	1.80	4.70	2.30	1.40	0.95	1.70	4.00	2.00
1210	3225	1.60	1.35	2.80	5.65	3.80	1.50	1.15	2.70	4.70	3.20	1.40	0.95	2.60	4.00	2.90
1210 ¹	3225	1.50	1.60	2.90	5.60	3.90	1.40	1.40	2.80	4.70	3.30	1.30	1.20	2.70	4.00	3.00
1808	4520	2.30	1.75	2.30	7.40	3.30	2.20	1.55	2.20	6.50	2.70	2.10	1.35	2.10	5.80	2.40
1812	4532	2.15	1.60	3.60	6.90	4.60	2.05	1.40	3.50	6.00	4.00	1.95	1.20	3.40	5.30	3.70
1825	4564	2.15	1.60	6.90	6.90	7.90	2.05	1.40	6.80	6.00	7.30	1.95	1.20	6.70	5.30	7.00
2220	5650	2.75	1.70	5.50	8.20	6.50	2.65	1.50	5.40	7.30	5.90	2.55	1.30	5.30	6.60	5.60
2225	5664	2.70	1.70	6.90	8.10	7.90	2.60	1.50	6.80	7.20	7.30	2.50	1.30	6.70	6.50	7.00

¹ Only for capacitance values \geq 22 μ F

Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes. KEMET only recommends wave soldering of EIA 0603, 0805 and 1206 case sizes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. **Density Level C:** For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC–7351).

Image below based on Density Level B for an EIA 1210 case size.





Soldering Process

Recommended Soldering Technique:

- Solder wave or solder reflow for EIA case sizes 0603, 0805 and 1206
- · All other EIA case sizes are limited to solder reflow only

Recommended Reflow Soldering Profile:

KEMET's families of surface mount multilayer ceramic capacitors (SMD MLCCs) are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J-STD-020 standard for moisture sensitivity testing. These devices can safely withstand a maximum of three reflow passes at these conditions.

Profile Feature	Termination Finish			
Frome reature	SnPb	100% Matte Sn		
Preheat/Soak				
Temperature Minimum (T _{Smin})	100°C	150°C		
Temperature Maximum (T _{Smax})	150°C	200°C		
Time (t _s) from T_{Smin} to T_{Smax}	60 – 120 seconds	60 – 120 seconds		
Ramp-Up Rate $(T_L \text{ to } T_P)$	3°C/second maximum	3°C/second maximum		
Liquidous Temperature (T_L)	183°C	217°C		
Time Above Liquidous (t_L)	60 – 150 seconds	60 – 150 seconds		
Peak Temperature (T _P)	235°C	260°C		
Time Within 5°C of Maximum Peak Temperature (t _P)	20 seconds maximum	30 seconds maximum		
Ramp-Down Rate $(T_P \text{ to } T_L)$	6°C/second maximum	6°C/second maximum		
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum		

Note 1: All temperatures refer to the center of the package, measured on the capacitor body surface that is facing up during assembly reflow.

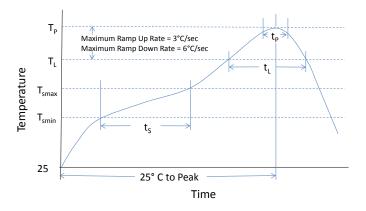




Table 4 – Performance & Reliability: Test Methods and Conditions

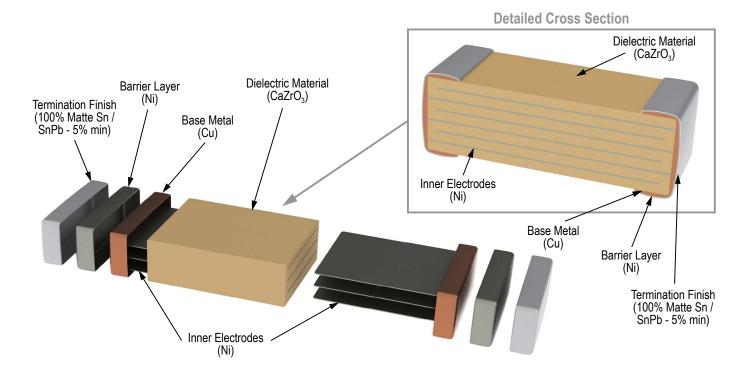
Stress	Reference	Test or Inspection Method	
Terminal Strength	JIS-C-6429	Appendix 1, Note: Force of 1.8 kg for 60 seconds.	
Board Flex	JIS-C-6429	Appendix 2, Note: Standard termination system – 2.0 mm (minimum) for all except 3 mm for C0G. Flexible termination system – 3.0 mm (minimum).	
		Magnification 50 X. Conditions:	
Solderability	J-STD-002	a) Method B, 4 hours at 155°C, dry heat at 235°C	
Solderability		b) Method B at 215°C category 3	
		c) Method D, category 3 at 260°C	
Temperature Cycling	JESD22 Method JA-104	1,000 cycles (-55°C to +125°C). Measurement at 24 hours +/- 2 hours after test conclusion.	
Discod Llumiditu	MIL-STD-202 Method 103 -	Load Humidity: 1,000 hours 85°C/85% RH and 200 VDC maximum. Add 100 K ohm resistor. Measurement at 24 hours +/- 2 hours after test conclusion.	
Biased Humidity		Low Volt Humidity: 1,000 hours 85°C/85% RH and 1.5 V. Add 100 K ohm resistor. Measurement at 24 hours +/- 2 hours after test conclusion.	
Moisture Resistance	MIL-STD-202 Method 106	t = 24 hours/cycle. Steps 7a and 7b not required. Unpowered. Measurement at 24 hours +/- 2 hours after test conclusion.	
Thermal Shock	MIL-STD-202 Method 107	-55°C/+125°C. Note: Number of cycles required – 300. Maximum transfer time – 20 seconds. Dwell time – 15 minutes. Air – Air.	
High Temperature Life	MIL-STD-202 Method 108	1,000 hours at 125°C (85°C for X5R, Z5U and Y5V) with 1.2 X rated voltage applied.	
Storage Life	MIL-STD-202 Method 108	150°C, 0 VDC for 1,000 hours.	
Vibration	MIL-STD-202 Method 204	 5 g's for 20 min., 12 cycles each of 3 orientations. Note: Use 8" X 5" PCB 0.031" thick 7 secure points on one long side and 2 secure points at corners of opposite sides. Parts mounted within 2 from any secure point. Test from 10 – 2,000 Hz 	
Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213, Condition F.	
Resistance to Solvents	MIL-STD-202 Method 215	Add aqueous wash chemical, OKEM Clean or equivalent.	

Storage and Handling

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature– reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 1.5 years of receipt.



Construction



Capacitor Marking (Optional):

Laser marking option is not available on:

- C0G, Ultra Stable X8R and Y5V dielectric devices
- · EIA 0402 case size devices
- EIA 0603 case size devices with Flexible Termination option.
- KPS Commercial and Automotive grade stacked devices.

These capacitors are supplied unmarked only.



Tape & Reel Packaging Information

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12 and 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.

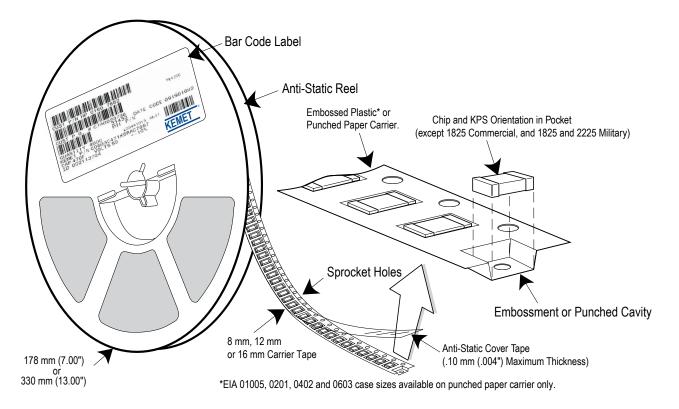


Table 5 – Carrier Tape Configuration, Embossed Plastic & Punched Paper (mm)

	Tape size (W)*	Embosse	ed Plastic	Punched Paper		
EIA Case Size		7" Reel	13" Reel	7" Reel	13" Reel	
		Pitch (P ₁)*		Pitch (P ₁)*		
01005 – 0402	8			2	2	
0603	8			4	4	
0805	8	4	4	4	4	
1206 – 1210	8	4	4	4	4	
1805 – 1808	12	4	4			
≥ 1812	12	8	8			
KPS 1210	12	8	8			
KPS 1812 & 2220	16	12	12			
Array 0508 & 0612	8	4	4			

*Refer to Figures 1 & 2 for W and P₁ carrier tape reference locations. *Refer to Tables 6 & 7 for tolerance specifications.



Figure 1 – Embossed (Plastic) Carrier Tape Dimensions

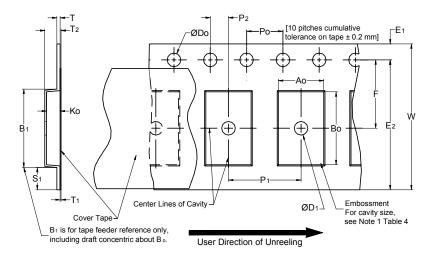


Table 6 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

	Constant Dimensions — Millimeters (Inches)								
Tape Size	D ₀	D ₁ Minimum Note 1	E ₁	P ₀	P ₂	R Reference Note 2	S ₁ Minimum Note 3	T Maximum	T₁ Maximum
8 mm		1.0 (0.039)				25.0 (0.984)			
12 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)		1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	30 (1.181)	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)
16 mm									
			Variable Dime	ensions — Mil	limeters (Inch	es)			
Tape Size Pitch B ₁ Maximum Note 4 E ₂ Minimum F P ₁ T ₂ Maximum W Maximum A ₀ ,B ₀ & K ₀						& K ₀			
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)		
12 mm	Single (4 mm) & Double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)	Not	ie 5
16 mm	Triple (12 mm)	12.1 (0.476)	14.25 (0.561)	7.5 ±0.05 (0.138 ±0.002)	12.0 ±0.10 (0.157 ±0.004)	4.6 (0.181)	16.3 (0.642)		

1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.

2. The tape with or without components shall pass around R without damage (see Figure 6).

3. If S₁ < 1.0 mm, there may not be enough area for cover tape to be properly applied (see EIA Standard 481 paragraph 4.3 section b).

4. B, dimension is a reference dimension for tape feeder clearance only.

5. The cavity defined by A_{α} , B_{α} and K_{α} shall surround the component with sufficient clearance that:

(a) the component does not protrude above the top surface of the carrier tape.

(b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.

(c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 3).

(d) lateral movement of the component is restricted to 0.5 mm maximum for 8 and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 4).

(e) for KPS Series product, A_0 and B_0 are measured on a plane 0.3 mm above the bottom of the pocket.

(f) see Addendum in EIA Standard 481 for standards relating to more precise taping requirements.



Figure 2 – Punched (Paper) Carrier Tape Dimensions

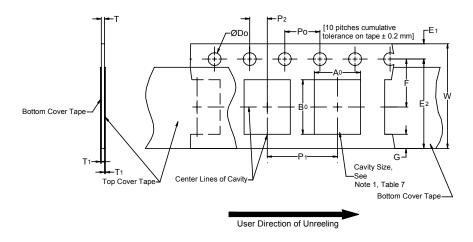


Table 7 – Punched (Paper) Carrier Tape Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)								
Tape Size	D ₀	E ₁	P ₀	P ₂	T₁ Maximum	G Minimum	R Reference Note 2	
8 mm	1.5 +0.10 -0.0 (0.059 +0.004 -0.0)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	0.10 (0.004) Maximum	0.75 (0.030)	25 (0.984)	
	Variable Dimensions — Millimeters (Inches)							
Tape Size	Tape Size Pitch E2 Minimum F P1 T Maximum W Maximum A0B0							
8 mm	Half (2 mm)	6.25	3.5 ±0.05	2.0 ±0.05 (0.079 ±0.002)	1.1	8.3 (0.327)	Note 1	
8 mm	Single (4 mm)	(0.246)	(0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	(0.098)	8.3 (0.327)	NOLE I	

1. The cavity defined by A_{α} , B_{α} and T shall surround the component with sufficient clearance that:

a) the component does not protrude beyond either surface of the carrier tape.

b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.

c) rotation of the component is limited to 20° maximum (see Figure 3).

d) lateral movement of the component is restricted to 0.5 mm maximum (see Figure 4).

e) see Addendum in EIA Standard 481 for standards relating to more precise taping requirements.

2. The tape with or without components shall pass around R without damage (see Figure 6).



Packaging Information Performance Notes

- 1. Cover Tape Break Force: 1.0 Kg minimum.
- 2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

Tape Width	Peel Strength
8 mm	0.1 to 1.0 Newton (10 to 100 gf)
12 and 16 mm	0.1 to 1.3 Newton (10 to 130 gf)

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ± 10 mm/minute. **3. Labeling:** Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards* 556 and 624.

Figure 3 – Maximum Component Rotation

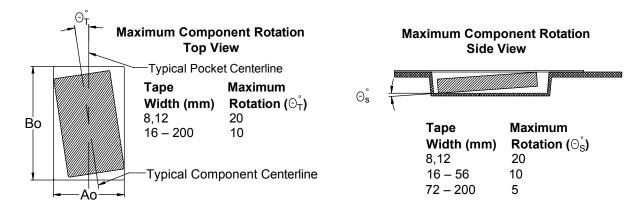


Figure 4 – Maximum Lateral Movement

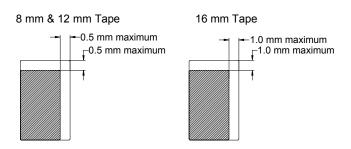


Figure 5 – Bending Radius

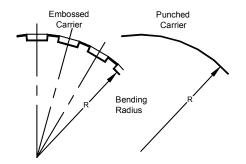
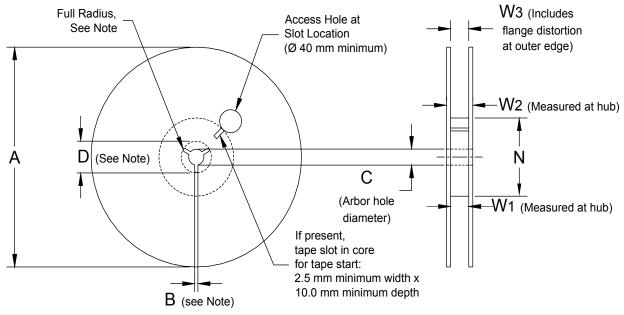




Figure 6 – Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

Table 8 – Reel Dimensions

Metric will govern

Constant Dimensions — Millimeters (Inches)								
Tape Size	A	B Minimum	С	D Minimum				
8 mm	178 ±0.20	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)				
12 mm	(7.008 ±0.008) or							
16 mm	330 ±0.20 (13.000 ±0.008)	()	()	()				
	Variable Dimensions — Millimeters (Inches)							
Tape Size	N Minimum	W ₁	W ₂ Maximum	W ₃				
8 mm		8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)					
12 mm	50 (1.969)	12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	Shall accommodate tape width without interference				
16 mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)					



Figure 7 – Tape Leader & Trailer Dimensions

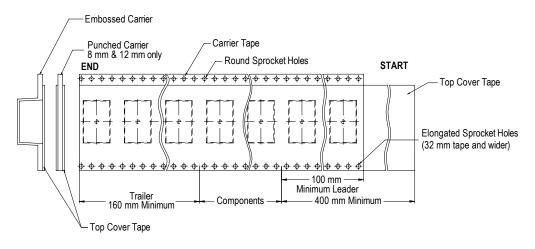
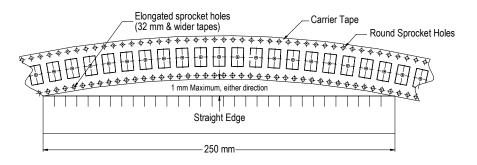


Figure 8 – Maximum Camber



Surface Mount Multilayer Ceramic Chip Capacitors (SMD MLCCs) High Voltage C0G Dielectric, 500 – 3,000 VDC (Commercial & Automotive Grade)



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